



Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	942
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-OFCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga115e-6ffn1704i

Table 2-5. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
FIFO	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1 and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output. A clock is required even in asynchronous read mode.

The EBR memory supports two forms of write behavior for dual port operation:

1. **Normal** — data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output.
2. **Write Through** — a copy of the input data appears at the output of the same port.

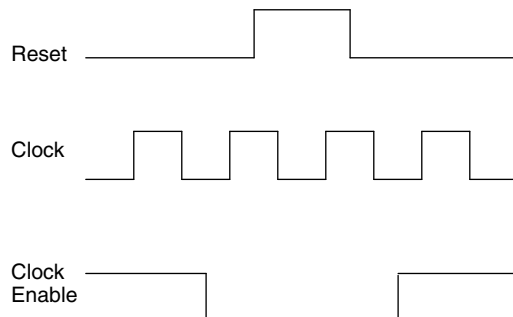
FIFO Configuration

The FIFO has a write port with Data-in, WCE, WE and WCLK signals. There is a separate read port with Data-out, RCE, RE and RCLK signals. The FIFO internally generates Almost Full, Full, Almost Empty, and Empty Flags. The Full and Almost Full flags are registered with WCLK. The Empty and Almost Empty flags are registered with RCLK.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the low-to-high transition of the reset, as shown in Figure 2-16.

Figure 2-16. EBR Asynchronous Reset (Including GSR) Timing Diagram



If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becoming active.

These instructions apply to all EBR RAM, ROM, FIFO and shift register implementations. For the EBR FIFO mode, the GSR signal is always enabled and the WE and RE signals act like the clock enable signals in Figure 2-16. The reset timing rules apply to the RPRreset input vs. the RE input and the RST input vs. the WE and RE inputs. Both RST and RPRreset are always asynchronous EBR inputs. For the EBR shift register mode, the GSR signal is always enabled and the local RESET pin is always asynchronous.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled. For more information about on-chip memory, see TN1094, [On-Chip Memory Usage Guide for LatticeSC Devices](#).

Programmable I/O Cells (PIC)

Each PIC contains four PIOs connected to their respective PURESPEED I/O Buffer which are then connected to the PADs as shown in Figure 2-17. The PIO Block supplies the output data (DO) and the Tri-state control signal (TO) to PURESPEED I/O buffer, and receives input (DI) from the buffer. The PIO contains advanced capabilities to allow the support of speeds up to 2Gbps. These include dedicated shift and DDR logic and adaptive input logic. The dedicated resources simplify the design of robust interfaces.

Table 2-6. Input/Output/Tristate Gearing Resource Rules

PIO	Input/Output Logic			Tri-State/Bidi	
	x1	x2	x4	x1	x2/x4
A	?	?	?	?	N/A
B	?	No I/O Logic	No I/O Logic	?	N/A
C	?	?	No I/O Logic	?	N/A
D	?	No I/O Logic	No I/O Logic	?	N/A

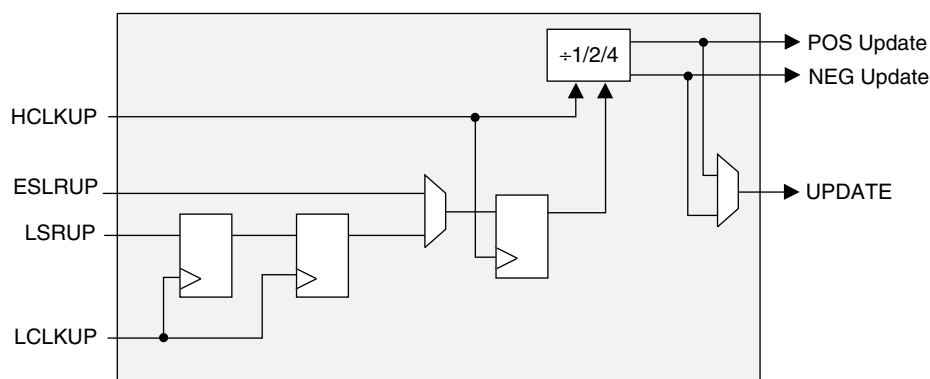
Note: Pin can still be used without I/O logic.

Control Logic Block

The control logic block allows the modification of control signals selected by the routing before they are used in the PIO. It can optionally invert all signals passing through it except the Global Set/Reset. Global Set/Reset can be enabled or disabled. It can route either the edge clock or the clock to the high-speed clock nets. The clock provided to the PIO by routing is used as the slow-speed clocks. In addition this block contains delays that can be inserted in the clock nets to enable Lattice's unique cycle boosting capability.

Update Block

The update block is used to generate the POS update and NEG update signals used by the DDR/Shift register blocks within the PIO. Note the update block is only required in shift modes. This is required in order to do the high speed to low speed handoff. One of these update signals is also selected and output from the PIC as the signal UPDATE. It consists of a shift chain that operates off either the high-speed input or output clock. The values of each register in the chain are set or reset depending on the desired mode of operation. The set/reset signal is generated from either the edge reset ELSR or the local reset LSR. These signals are optionally inverted by the Control Logic Block and provided to the update block as ELSRUP and LSRUP. The Lattice design tools automatically configure and connect the update block when one of the DDR or shift register primitives is used.

Figure 2-25. Update Block

PURESPEED I/O Buffer

Each I/O is associated with a flexible buffer referred to as PURESPEED I/O buffer. These buffers are arranged around the periphery of the device in seven groups referred to as Banks. The PURESPEED I/O buffers allow users to implement the wide variety of standards that are found in today's systems including LVCMOS, SSTL, HSTL, LVDS and LVPECL. The availability of programmable on-chip termination for both input and output use, further enhances the utility of these buffers.

Figure 2-26. LatticeSC Banks

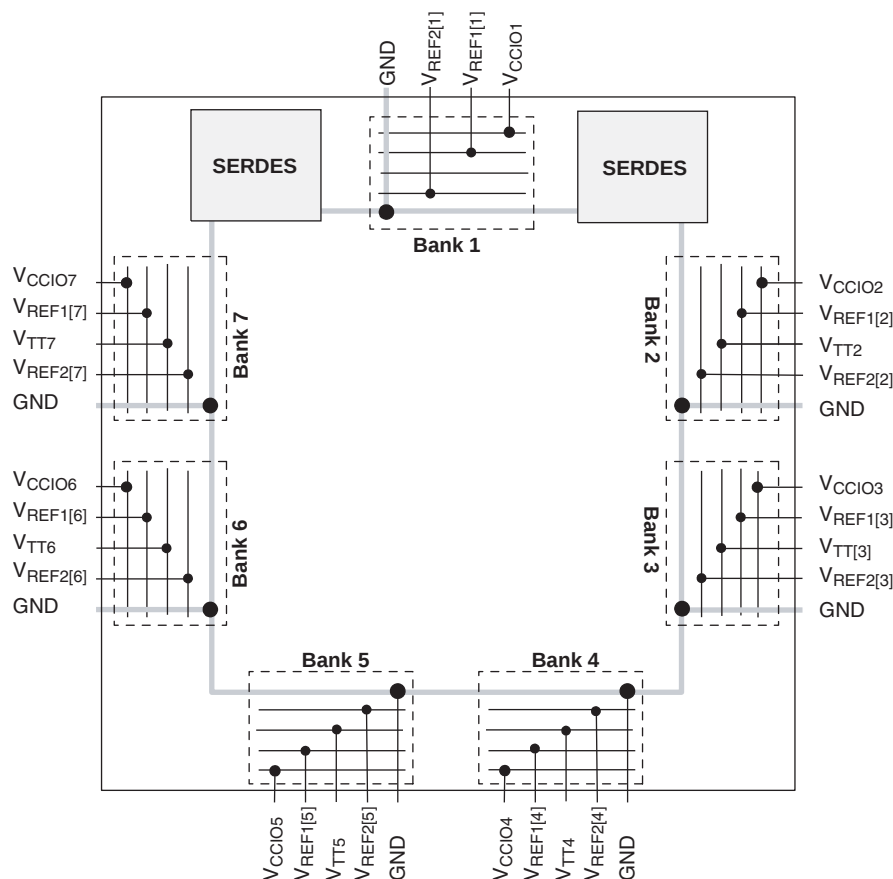


Table 2-7. Maximum Number of I/Os Per Bank in LatticeSC Family

Device	LFSC/M15	LFSC/M25	LFSC/M40	LFSC/M80	LFSC/M115
Bank1	104	80	136	80	136
Bank2	28	36	60	96	136
Bank3	60	84	96	132	156
Bank4	72	100	124	184	208
Bank5	72	100	124	184	208
Bank6	60	84	96	132	156
Bank7	28	36	60	96	136

Note: Not all the I/Os of the Banks are available in all the packages

The LatticeSC devices contain three types of PURESPEED I/O buffers:

1. Left and Right Sides (Banks 2, 3, 6 and 7)

These buffers can support LVCMOS standards up to 2.5V. A differential output driver (for LVDS and RSFS) is provided on all primary PIO pairs (A and B) and differential receivers are available on all pairs. Complimentary drivers are available. Adaptive input logic is available on PIOs A or C.

2. Top Side (Bank 1)

These buffers can support LVCMOS standards up to 3.3V, including PCI33, PCI-X33 and SSTL-33. Differential receivers are provided on all PIO pairs but differential drivers for LVDS and RSFS are not available. Adaptive input logic is not available on this side. Complimentary output drivers are available.

LatticeSC/M Internal Timing Parameters¹ (Continued)

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
EBR Timing									
t _{CO_EBR}	CK_Q_DEL	Clock (Read) to output from Address or Data	—	1.900	—	2.116	—	2.335	ns
t _{COO_EBR}	CK_Q_DEL	Clock (Write) to output from EBR output Register	0.390	—	0.444	—	0.498	—	ns
t _{SUDATA_EBR}	D_CK_SET	Setup Data to EBR Memory (Write clk)	-0.173	—	-0.192	—	-0.210	—	ns
t _{HDATA_EBR}	D_CK_HLD	Hold Data to EBR Memory (Write clk)	0.276	—	0.305	—	0.335	—	ns
t _{SUADDR_EBR}	A_CK_SET	Setup Address to EBR Memory (Write clk)	-0.165	—	-0.182	—	-0.200	—	ns
t _{HADDR_EBR}	A_CK_HLD	Hold Address to EBR Memory (Write clk)	0.269	—	0.298	—	0.327	—	ns
t _{SUWREN_EBR}	CE_CK_SET	Setup Write/Read Enable to EBR Memory (Write/Read clk)	0.225	—	0.226	—	0.226	—	ns
t _{HWREN_EBR}	CE_CK_HLD	Hold Write/Read Enable to EBR Memory (write/read clk)	0.073	—	0.095	—	0.116	—	ns
t _{SUCE_EBR}	CS_CK_SET	Clock Enable Setup Time to EBR Output Register (Read clk)	0.261	—	0.269	—	0.276	—	ns
t _{HCE_EBR}	CS_CK_HLD	Clock Enable Hold Time to EBR Out-put Register (Read clk)	0.023	—	0.039	—	0.055	—	ns
t _{RSTO_EBR}	RESET_Q_DEL	Reset To Output Delay Time from EBR Output Register (asynchronous)	—	0.589	—	0.673	—	0.757	ns
Cycle Boosting Timing									
t _{DEL1}	DEL1	Cycle boosting delay 1 applies to PIO, PFU, EBR	—	0.480	—	0.524	—	0.570	ns
t _{DEL2}	DEL2	Cycle boosting delay 2 applies to PIO, PFU, EBR	—	0.922	—	1.005	—	1.090	ns
t _{DEL3}	DEL3	Cycle boosting delay 3 applies to PIO, PFU, EBR	—	1.366	—	1.488	—	1.612	ns

1. Complete timing parameters for a user design will be incorporated when running ispLEVER. This is a sampling of the key timing parameters.

sysCLOCK DLL Timing**Over Recommended Operating Conditions**

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		100	—	700	MHz
f_{OUTOP}	Output Clock Frequency (CLKOP)		100	—	700	MHz
f_{OUTOS}	Output Clock Frequency (CLKOS)		25	—	700	MHz
AC Characteristics						
t_{DUTY}	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, 50% duty cycle input clock, duty cycle correction turned off, time reference delay mode)	38	—	62	%
t_{DUTYRD}	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, arbitrary duty cycle input clock, duty cycle correction turned on, time reference delay mode)	45	—	55	%
$t_{DUTYCIR}$	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, arbitrary duty cycle input clock, duty cycle correction turned on, clock injection removal mode)	40	—	60	%
t_{OPJIT}^1	Output Clock Period Jitter		—	—	200	ps
t_{CPJIT}^1	Output Clock Cycle-to-Cycle Jitter		—	—	200	ps
t_{SKEW}	Output Clock to Clock Skew (Between Two Outputs with the Same Phase Setting)		—	—	100	ps
t_{LOCK}	DLL Lock-in Time		8	—	18500	cycles
t_{IDUTY}	Input Clock Duty Cycle	Applies to all operating conditions	35	—	65	%
t_{IPJIT}	Input Clock Period Jitter		—	—	+/- 250	ps
t_{HI}	Input Clock High Time	At 80% level	500	—	—	ps
t_{LO}	Input Clock Low Time	At 20% level	500	—	—	ps
t_{RSWD}	Reset Signal Pulse Width		3	—	—	ns
t_{FDEL}	Timeshift Delay Step Size		35	45	80	ps
t_{DLL}	Delay Through the DLL when No Delay Taps are Chosen but Not in Bypass Mode.		—	760	—	ps

1. Values are measured with FPGA logic active, no additional I/Os toggling and REFCLK total jitter = 30 ps.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
RESP_[ULC/URC]	—	Calibration resistor to be placed between this pin and either ground or RESPN_[ULC/URC]. RESPN_[ULC/URC] is available on select packages. If available, connection of calibration resistor between RESP_[ULC/URC] and RESPN_[ULC/URC] takes precedence over connection of calibration resistor between RESP_[ULC/URC] and ground. Note: only one per side of the device. Value: 4.02K ohm +/- 1% ohm.
RESPN_[ULC/URC]	—	Available on selected packages. If available, calibration resistor should be placed between RESP_[ULC/URC] and RESPN_[ULC/URC] instead of between RESP_[ULC/URC] and ground. Note: only one per side of the device. Value: 4.02K ohm +/- 1% ohm.
[A:D]_VDDIBx_[L/R]	—	Input buffer power supply for channel x (1.2V/1.5V) on left [L] or right [R] side of device.
[A:D]_VDDOBx_[L/R]	—	Output buffer power supply for channel x (1.2V/1.5V) on left [L] or right [R] side of device.
[A:D]_VDDAX25_[L/R]	—	Auxiliary power for input and output termination (2.5V) on left [L] or right [R] side of device.

1. The ispLEVER software tools may specify VDDR_X, VDDT_X, VDDP and VCCL pins. These pins should be considered VCC12 pins.
Note: Signals listed as Signal A / Signal B define the same physical pin that is used for different functions based on configuration mode.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AJ27	GND	-		GND	-	
AF23	GND	-		GND	-	
AF22	GND	-		GND	-	
AE27	GND	-		GND	-	
AA27	GND	-		GND	-	
AB29	GND	-		GND	-	
Y26	GND	-		GND	-	
AC30	GND	-		GND	-	
Y29	GND	-		GND	-	
F30	GND	-		GND	-	
E27	GND	-		GND	-	
F27	GND	-		GND	-	
P25	GND	-		GND	-	
H29	GND	-		GND	-	
K29	GND	-		GND	-	
R24	GND	-		GND	-	
M28	GND	-		GND	-	
J27	GND	-		GND	-	
N26	GND	-		GND	-	
E20	GND	-		GND	-	
E21	GND	-		GND	-	
F21	GND	-		GND	-	
F23	GND	-		GND	-	
G23	GND	-		GND	-	
D21	GND	-		GND	-	
D20	GND	-		GND	-	
E18	GND	-		GND	-	
C20	GND	-		GND	-	
C11	GND	-		GND	-	
A12	GND	-		GND	-	
E11	GND	-		GND	-	
F8	GND	-		GND	-	
G8	GND	-		GND	-	
D11	GND	-		GND	-	
D10	GND	-		GND	-	
H7	GND	-		GND	-	
F10	GND	-		GND	-	
E10	GND	-		GND	-	
AC16	NC	-		NC	-	
J22	VCC	-		VCC	-	
J9	VCC	-		VCC	-	
B2	NC	-		NC	-	
C2	RESPN_ULC	-		RESPN_ULC	-	
C29	RESPN_URC	-		RESPN_URC	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AM21	PB29A	5		PB38A	5	
AM20	PB29B	5		PB38B	5	
AH21	PB29C	5		PB38C	5	
AH20	PB29D	5		PB38D	5	
AJ18	PB31A	5		PB39A	5	
AK18	PB31B	5		PB39B	5	
AH19	PB31C	5		PB39C	5	
AH18	PB31D	5		PB39D	5	
AL19	PB32A	5		PB41A	5	
AM19	PB32B	5		PB41B	5	
AH17	PB32C	5		PB41C	5	
AG17	PB32D	5		PB41D	5	
AL18	PB33A	5		PB42A	5	
AM18	PB33B	5		PB42B	5	
AC17	PB33C	5		PB42C	5	
AD17	PB33D	5		PB42D	5	
AL17	PB35A	5		PB43A	5	
AM17	PB35B	5		PB43B	5	
AE17	PB35C	5		PB43C	5	
AF17	PB35D	5		PB43D	5	
AM16	PB37A	4		PB45A	4	
AL16	PB37B	4		PB45B	4	
AF16	PB37C	4		PB45C	4	
AE16	PB37D	4		PB45D	4	
AM15	PB38A	4		PB46A	4	
AL15	PB38B	4		PB46B	4	
AD16	PB38C	4		PB46C	4	
AC16	PB38D	4		PB46D	4	
AM14	PB39A	4		PB47A	4	
AL14	PB39B	4		PB47B	4	
AG16	PB39C	4		PB47C	4	
AH16	PB39D	4		PB47D	4	
AK15	PB41A	4		PB49A	4	
AJ15	PB41B	4		PB49B	4	
AH15	PB41C	4		PB49C	4	
AH14	PB41D	4		PB49D	4	
AM13	PB42A	4		PB50A	4	
AM12	PB42B	4		PB50B	4	
AH13	PB42C	4		PB50C	4	
AH12	PB42D	4		PB50D	4	
AK14	PB43A	4		PB51A	4	
AJ14	PB43B	4		PB51B	4	
AE15	PB43C	4		PB51C	4	
AD15	PB43D	4		PB51D	4	
AL13	PB46A	4	PCLKT4_2	PB53A	4	PCLKT4_2
AL12	PB46B	4	PCLKC4_2	PB53B	4	PCLKC4_2
AG14	PB46C	4	PCLKT4_7	PB53C	4	PCLKT4_7
AG13	PB46D	4	PCLKC4_7	PB53D	4	PCLKC4_7
AM11	PB47A	4	PCLKT4_1	PB54A	4	PCLKT4_1
AM10	PB47B	4	PCLKC4_1	PB54B	4	PCLKC4_1

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
U12	VCC12	-		VCC12	-	
U21	VCC12	-		VCC12	-	
AA16	VCC12	-		VCC12	-	
AA17	VCC12	-		VCC12	-	
M14	VCC12	-		VCC12	-	
P12	VCC12	-		VCC12	-	
W12	VCC12	-		VCC12	-	
AA14	VCC12	-		VCC12	-	
AA19	VCC12	-		VCC12	-	
W21	VCC12	-		VCC12	-	
P21	VCC12	-		VCC12	-	
M19	VCC12	-		VCC12	-	
A2	GND	-		GND	-	
A10	GND	-		GND	-	
E28	NC	-		NC	-	
E5	NC	-		NC	-	
F10	NC	-		NC	-	
E10	NC	-		NC	-	
E23	NC	-		NC	-	
F23	NC	-		NC	-	

1. Differential pair grouping within a PIC is A (True) and B (Complement) and C (True) and D (Complement).
2. The LatticeSC/M25 and LatticeSC/M40 in a 1020-pin package support a 16-bit MPI interface.

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCI/O Bank	Dual Function	Ball Function	VCCI/O Bank	Dual Function
AD8	PR65C	3		PR89C	3	
AJ3	PR65B	3		PR89B	3	
AH3	PR65A	3		PR89A	3	
AD7	PR62D	3		PR86D	3	
AC7	PR62C	3		PR86C	3	
AJ2	PR62B	3		PR86B	3	
AH2	PR62A	3		PR86A	3	
AF6	PR61D	3		PR85D	3	
AF5	PR61C	3		PR85C	3	
AF4	PR61B	3		PR85B	3	
AE4	PR61A	3		PR85A	3	
AD6	PR60D	3		PR84D	3	
AC6	PR60C	3		PR84C	3	
AG2	PR60B	3		PR84B	3	
AF2	PR60A	3		PR84A	3	
AC8	PR58D	3		PR82D	3	
AB8	PR58C	3		PR82C	3	
AK1	PR58B	3		PR82B	3	
AJ1	PR58A	3		PR82A	3	
AB10	PR57D	3		PR81D	3	
AA10	PR57C	3		PR81C	3	
AF3	PR57B	3		PR81B	3	
AE3	PR57A	3		PR81A	3	
AE5	PR56D	3		PR80D	3	
AD5	PR56C	3		PR80C	3	
AE2	PR56B	3		PR80B	3	
AD2	PR56A	3		PR80A	3	
AC5	PR53D	3		PR78D	3	
AB5	PR53C	3		PR78C	3	
AF1	PR53B	3		PR78B	3	
AE1	PR53A	3		PR78A	3	
AA11	PR52D	3		PR77D	3	
Y11	PR52C	3		PR77C	3	
AC4	PR52B	3		PR77B	3	
AB4	PR52A	3		PR77A	3	
AA8	PR51D	3	DIFFR_3	PR76D	3	DIFFR_3
AA9	PR51C	3		PR76C	3	
AC3	PR51B	3		PR76B	3	
AB3	PR51A	3		PR76A	3	
AA7	PR49D	3		PR65D	3	
Y7	PR49C	3		PR65C	3	
AA2	PR49B	3		PR65B	3	
Y2	PR49A	3		PR65A	3	
AA6	PR48D	3		PR63D	3	
Y6	PR48C	3		PR63C	3	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
W7	GND	-		GND	-	
AA14	VCC	-		VCC	-	
AA16	VCC	-		VCC	-	
AA17	VCC	-		VCC	-	
AA18	VCC	-		VCC	-	
AA19	VCC	-		VCC	-	
AA21	VCC	-		VCC	-	
AB13	VCC	-		VCC	-	
AB22	VCC	-		VCC	-	
N13	VCC	-		VCC	-	
N22	VCC	-		VCC	-	
P14	VCC	-		VCC	-	
P16	VCC	-		VCC	-	
P17	VCC	-		VCC	-	
P18	VCC	-		VCC	-	
P19	VCC	-		VCC	-	
P21	VCC	-		VCC	-	
R15	VCC	-		VCC	-	
R17	VCC	-		VCC	-	
R18	VCC	-		VCC	-	
R20	VCC	-		VCC	-	
T14	VCC	-		VCC	-	
T16	VCC	-		VCC	-	
T19	VCC	-		VCC	-	
T21	VCC	-		VCC	-	
U14	VCC	-		VCC	-	
U15	VCC	-		VCC	-	
U17	VCC	-		VCC	-	
U18	VCC	-		VCC	-	
U20	VCC	-		VCC	-	
U21	VCC	-		VCC	-	
V14	VCC	-		VCC	-	
V15	VCC	-		VCC	-	
V17	VCC	-		VCC	-	
V18	VCC	-		VCC	-	
V20	VCC	-		VCC	-	
V21	VCC	-		VCC	-	
W14	VCC	-		VCC	-	
W16	VCC	-		VCC	-	
W19	VCC	-		VCC	-	
W21	VCC	-		VCC	-	
Y15	VCC	-		VCC	-	
Y17	VCC	-		VCC	-	
Y18	VCC	-		VCC	-	
Y20	VCC	-		VCC	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
G27	A_REFCLKP_L	-	
H27	A_REFCLKN_L	-	
H25	VCC12	-	
H26	RESP_ULC	-	
B33	RESETN	1	
C34	TSALLN	1	
D34	DONE	1	
C33	INITN	1	
J27	M0	1	
K27	M1	1	
M26	M2	1	
L26	M3	1	
F30	PL15A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
G30	PL15B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
H28	PL15C	7	
J28	PL15D	7	
F31	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
G31	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
N25	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
P25	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
D33	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
E33	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
H29	PL18C	7	
J29	PL18D	7	VREF2_7
F32	PL19A	7	
G32	PL19B	7	
P26	PL19C	7	
N26	PL19D	7	
H30	PL26A	7	
J30	PL26B	7	
L28	PL26C	7	
M28	PL26D	7	
J31	PL43A	7	
K31	PL43B	7	
L27	PL43C	7	VREF1_7
M27	PL43D	7	DIFFR_7
J32	PL45A	7	
K32	PL45B	7	
L29	PL45C	7	
M29	PL45D	7	
H33	PL47A	7	
J33	PL47B	7	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AP27	PB26A	5	
AP26	PB26B	5	
AK25	PB26C	5	
AK24	PB26D	5	
AN25	PB29A	5	
AN24	PB29B	5	
AE22	PB29C	5	
AE21	PB29D	5	
AM26	PB31A	5	
AM25	PB31B	5	
AF22	PB31C	5	
AF21	PB31D	5	
AN23	PB47A	5	
AN22	PB47B	5	
AP23	PB57A	5	
AP22	PB57B	5	
AG21	PB57C	5	
AG20	PB57D	5	
AP25	PB50A	5	PCLKT5_3
AP24	PB50B	5	PCLKC5_3
AD21	PB50C	5	PCLKT5_4
AD20	PB50D	5	PCLKC5_4
AL23	PB51A	5	PCLKT5_5
AL22	PB51B	5	PCLKC5_5
AH24	PB51C	5	
AH23	PB51D	5	
AM23	PB53A	5	PCLKT5_0
AM22	PB53B	5	PCLKC5_0
AJ24	PB53C	5	
AJ23	PB53D	5	VREF2_5
AN21	PB54A	5	PCLKT5_1
AN20	PB54B	5	PCLKC5_1
AE19	PB54C	5	PCLKT5_6
AD19	PB54D	5	PCLKC5_6
AK21	PB55A	5	PCLKT5_2
AK20	PB55B	5	PCLKC5_2
AK23	PB55C	5	PCLKT5_7
AK22	PB55D	5	PCLKC5_7
AL20	PB58A	5	
AL19	PB58B	5	
AG19	PB58C	5	
AF19	PB58D	5	
AP21	PB61A	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP8	PB117D	4		PB131D	4	
AY3	PB119A	4		PB133A	4	
AW3	PB119B	4		PB133B	4	
AR6	PB119C	4		PB133C	4	
AR5	PB119D	4		PB133D	4	
AU5	PB120A	4		PB134A	4	
AV5	PB120B	4		PB134B	4	
AL12	PB120C	4		PB134C	4	
AL11	PB120D	4		PB134D	4	
AV3	PB121A	4		PB135A	4	
AV4	PB121B	4		PB135B	4	
AN9	PB121C	4		PB135C	4	
AN8	PB121D	4		PB135D	4	
AW1	PB123A	4		PB138A	4	
AY1	PB123B	4		PB138B	4	
AK14	PB123C	4	VREF1_4	PB138C	4	VREF1_4
AK13	PB123D	4		PB138D	4	
AV2	PB124A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AW2	PB124B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D	PB139B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AM10	PB124C	4		PB139C	4	
AM9	PB124D	4		PB139D	4	
AV1	PB125A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AU1	PB125B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AL10	PB125C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AL9	PB125D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB141D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AT3	PROBE_VCC	-		PROBE_VCC	-	
AU2	PROBE_GND	-		PROBE_GND	-	
AP7	PR95D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AN7	PR95C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AR3	PR95B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AR4	PR95A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AP6	PR94D	3		PR116D	3	
AN6	PR94C	3		PR116C	3	
AT2	PR94B	3		PR116B	3	
AR2	PR94A	3		PR116A	3	
AM6	PR93D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AL6	PR93C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AP5	PR93B	3		PR115B	3	
AN5	PR93A	3		PR115A	3	
AL8	PR91D	3		PR112D	3	
AK8	PR91C	3		PR112C	3	
AP2	PR91B	3		PR112B	3	
AN2	PR91A	3		PR112A	3	
AJ12	PR90D	3		PR109D	3	
AH12	PR90C	3		PR109C	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AM27	GND	-		GND	-	
AM36	GND	-		GND	-	
AM7	GND	-		GND	-	
AP4	GND	-		GND	-	
AP40	GND	-		GND	-	
AR14	GND	-		GND	-	
AR20	GND	-		GND	-	
AR23	GND	-		GND	-	
AR29	GND	-		GND	-	
AR35	GND	-		GND	-	
AR8	GND	-		GND	-	
AT11	GND	-		GND	-	
AT17	GND	-		GND	-	
AT26	GND	-		GND	-	
AT32	GND	-		GND	-	
AU3	GND	-		GND	-	
AU39	GND	-		GND	-	
AW12	GND	-		GND	-	
AW18	GND	-		GND	-	
AW22	GND	-		GND	-	
AW28	GND	-		GND	-	
AW34	GND	-		GND	-	
AW6	GND	-		GND	-	
AY15	GND	-		GND	-	
AY21	GND	-		GND	-	
AY25	GND	-		GND	-	
AY31	GND	-		GND	-	
AY37	GND	-		GND	-	
AY9	GND	-		GND	-	
B1	GND	-		GND	-	
B42	GND	-		GND	-	
BA1	GND	-		GND	-	
BA42	GND	-		GND	-	
BB2	GND	-		GND	-	
BB41	GND	-		GND	-	
C10	GND	-		GND	-	
C12	GND	-		GND	-	
C13	GND	-		GND	-	
C16	GND	-		GND	-	
C18	GND	-		GND	-	
C19	GND	-		GND	-	
C22	GND	-		GND	-	
C24	GND	-		GND	-	
C27	GND	-		GND	-	
C28	GND	-		GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AW25	VCCIO5	-		VCCIO5	-	
AW31	VCCIO5	-		VCCIO5	-	
AW37	VCCIO5	-		VCCIO5	-	
AY22	VCCIO5	-		VCCIO5	-	
AY28	VCCIO5	-		VCCIO5	-	
AY34	VCCIO5	-		VCCIO5	-	
AB39	VCCIO6	-		VCCIO6	-	
AC36	VCCIO6	-		VCCIO6	-	
AD32	VCCIO6	-		VCCIO6	-	
AE40	VCCIO6	-		VCCIO6	-	
AF35	VCCIO6	-		VCCIO6	-	
AG31	VCCIO6	-		VCCIO6	-	
AH39	VCCIO6	-		VCCIO6	-	
AJ36	VCCIO6	-		VCCIO6	-	
AK32	VCCIO6	-		VCCIO6	-	
AL40	VCCIO6	-		VCCIO6	-	
AM35	VCCIO6	-		VCCIO6	-	
AP39	VCCIO6	-		VCCIO6	-	
AR36	VCCIO6	-		VCCIO6	-	
AU40	VCCIO6	-		VCCIO6	-	
AA40	VCCIO7	-		VCCIO7	-	
H36	VCCIO7	-		VCCIO7	-	
J40	VCCIO7	-		VCCIO7	-	
L35	VCCIO7	-		VCCIO7	-	
M39	VCCIO7	-		VCCIO7	-	
P36	VCCIO7	-		VCCIO7	-	
R40	VCCIO7	-		VCCIO7	-	
T31	VCCIO7	-		VCCIO7	-	
U35	VCCIO7	-		VCCIO7	-	
V39	VCCIO7	-		VCCIO7	-	
W32	VCCIO7	-		VCCIO7	-	
Y36	VCCIO7	-		VCCIO7	-	
AA14	VTT_2	2		VTT_2	2	
AA15	VTT_2	2		VTT_2	2	
R12	VTT_2	2		VTT_2	2	
V14	VTT_2	2		VTT_2	2	
AB14	VTT_3	3		VTT_3	3	
AB15	VTT_3	3		VTT_3	3	
AE14	VTT_3	3		VTT_3	3	
AJ13	VTT_3	3		VTT_3	3	
AH21	VTT_4	4		VTT_4	4	
AJ18	VTT_4	4		VTT_4	4	
AJ19	VTT_4	4		VTT_4	4	
AJ20	VTT_4	4		VTT_4	4	
AJ21	VTT_4	4		VTT_4	4	

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-6FF1020I ¹	-6	Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-5FF1020I ¹	-5	Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-6FC1152I ²	-6	Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FC1152I ²	-5	Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-6FF1152I	-6	Organic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FF1152I	-5	Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-6FC1152I ¹	-6	Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-5FC1152I ¹	-5	Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-6FF1152I	-6	Organic fcBGA	1152	IND	80.1
LFSC3GA80E-5FF1152I	-5	Organic fcBGA	1152	IND	80.1
LFSC3GA80E-6FC1704I ¹	-6	Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-5FC1704I ¹	-5	Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-6FF1704I	-6	Organic fcBGA	1704	IND	80.1
LFSC3GA80E-5FF1704I	-5	Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-6FC1152I ¹	-6	Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FC1152I ¹	-5	Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FF1152I	-6	Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FF1152I	-5	Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FC1704I ¹	-6	Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FC1704I ¹	-5	Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-6FF1704I	-6	Organic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FF1704I	-5	Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-7FFN1020C ¹	-7	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-6FFN1020C ¹	-6	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-5FFN1020C ¹	-5	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-7FCN1152C ²	-7	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-6FCN1152C ²	-6	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-5FCN1152C ²	-5	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-7FFN1020C ¹	-7	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-6FFN1020C ¹	-6	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-5FFN1020C ¹	-5	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-7FFAN1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-6FFAN1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-5FFAN1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-7FCN1152C ²	-7	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FCN1152C ²	-6	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FCN1152C ²	-5	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-7FFN1152C	-7	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FFN1152C	-6	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FFN1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSC3GA80E-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSC3GA80E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-7FCN1152C ¹	-7	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FCN1704C ¹	-7	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-7FFN1704C	-7	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152C ¹	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-5FCN1152C ¹	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSC3GA115E-6FCN1704C ¹	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-5FCN1704C ¹	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSC3GA115E-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).